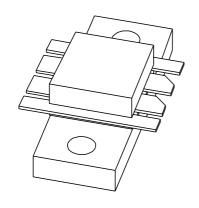
DISCRETE SEMICONDUCTORS

DATA SHEET



BLF246BVHF push-pull power MOS transistor

Product specification Supersedes data of 2000 Feb 04

2001 Oct 10





VHF push-pull power MOS transistor

BLF246B

FEATURES

- · High power gain
- · Easy power control
- · Good thermal stability
- Gold metallization ensures excellent reliability.

APPLICATIONS

Large signal applications in the VHF frequency range.

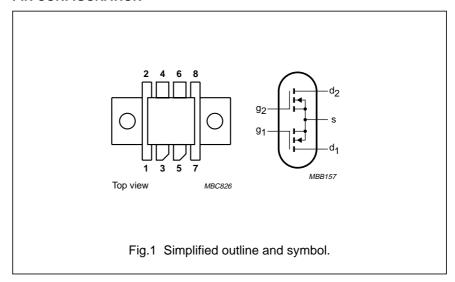
DESCRIPTION

Silicon N-channel enhancement mode vertical D-MOS push-pull transistor encapsulated in an 8-lead SOT161A balanced flange package with a ceramic cap. All leads are isolated from the flange.

PINNING - SOT161A

PIN	DESCRIPTION			
1	source			
2	source			
3	drain 1			
4	gate 1			
5	drain 2			
6	gate 2			
7	source			
8	source			

PIN CONFIGURATION



CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A, and SNW-FQ-302B.

WARNING Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

QUICK REFERENCE DATA

RF performance at T_h = 25 °C in a push-pull common source test circuit.

MODE OF OPERATION	f	V _{DS}	P _L	G _р	η _D
	(MHz)	(V)	(W)	(dВ)	(%)
CW, class-AB	175	28	60	>14	>55

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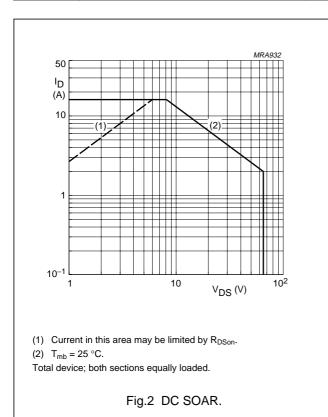
LIMITING VALUES

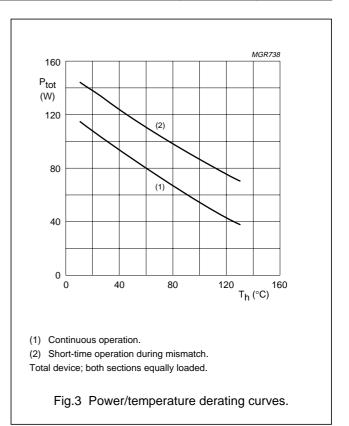
In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT		
Per transis	Per transistor section unless otherwise specified						
V _{DS}	drain-source voltage		_	65	V		
V_{GS}	gate-source voltage		_	±20	V		
I _D	drain current (DC)		_	8	Α		
P _{tot}	total power dissipation	$T_{mb} \le 25$ °C total device; both sections equally loaded	_	130	W		
T _{stg}	storage temperature		-65	+150	°C		
T _i	junction temperature		_	200	°C		

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-mb}	thermal resistance from junction to mounting base	total device; both sections equally loaded	1.35	K/W
R _{th mb-h}	thermal resistance from mounting base to heatsink	total device; both sections equally loaded	0.25	K/W





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CHARACTERISTICS

 $T_i = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	PARAMETER CONDITIONS		TYP.	MAX.	UNIT		
Per transis	Per transistor section							
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0; I _D = 10 mA	65	_	-	V		
I _{DSS}	drain-source leakage current	V _{GS} = 0; V _{DS} = 28 V	_	_	2	mA		
I _{GSS}	gate-source leakage current	$V_{GS} = \pm 20 \text{ V}; V_{DS} = 0$	_	_	1	μΑ		
V_{GSth}	gate-source threshold voltage	I _D = 10 mA; V _{DS} = 10 V	2	_	4.5	V		
9 _{fs}	forward transconductance	I _D = 1.5 A; V _{DS} = 10 V	1.2	1.8	_	S		
R _{DSon}	drain-source on-state resistance	I _D = 1.5 A; V _{GS} = 10 V	_	0.4	0.75	Ω		
I _{DSX}	on-state drain current	V _{GS} = 10 V; V _{DS} = 10 V	_	10	_	А		
C _{is}	input capacitance	$V_{GS} = 0$; $V_{DS} = 28 \text{ V}$; $f = 1 \text{ MHz}$	_	125	_	pF		
C _{os}	output capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	_	75	_	pF		
C _{rs}	feedback capacitance	$V_{GS} = 0$; $V_{DS} = 28 \text{ V}$; $f = 1 \text{ MHz}$	_	11	_	pF		

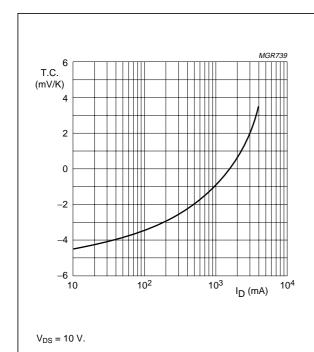
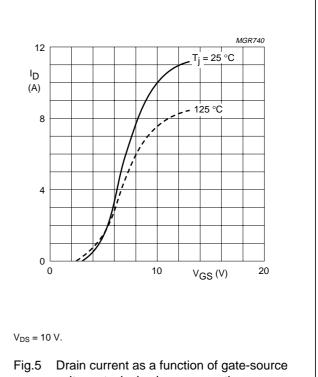


Fig.4 Temperature coefficient of gate-source voltage as a function of drain current; typical values per section.

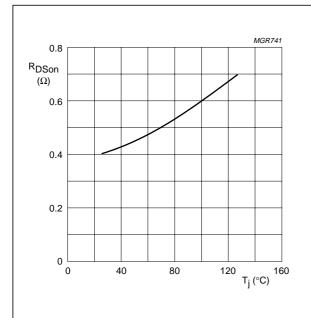


voltage; typical values per section.

Product specification Philips Semiconductors

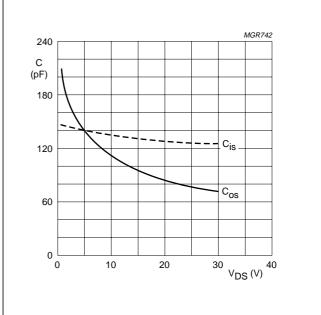
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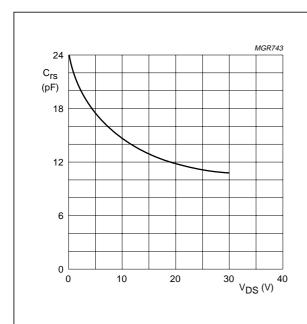
 $V_{GS} = 10 \text{ V}; I_D = 1.5 \text{ A}.$

Fig.6 Drain-source on-state resistance as a function of junction temperature; typical values per section.



 $V_{GS} = 0$; f = 1 MHz.

Input and output capacitance as functions of drain-source voltage; typical values per section.



 $V_{GS} = 0$; f = 1 MHz.

Feedback capacitance as a function of drain-source voltage; typical values per section.

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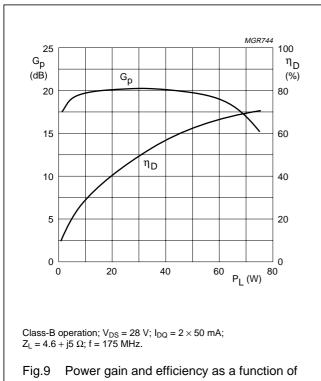
APPLICATION INFORMATION

RF performance in CW operation in a push-pull, common source, class-B circuit. $T_h = 25$ °C; $R_{th\ mb-h} = 0.25$ K/W; unless otherwise specified.

MODE OF OPERATION	f (MHz)	V _{DS} (V)	I _{DQ} (mA)	P _L (W)	G _p (dB)	η _D (%)
CW, class-B	175	28	2 × 50	60	>14	>55
					typ. 19	typ. 65

Ruggedness in class-B operation

The BLF246B is capable of withstanding a load mismatch corresponding to VSWR = 50: 1 through all phases under the following conditions: V_{DS} = 28 V; f = 175 MHz at rated output power.



load power; typical values per section.

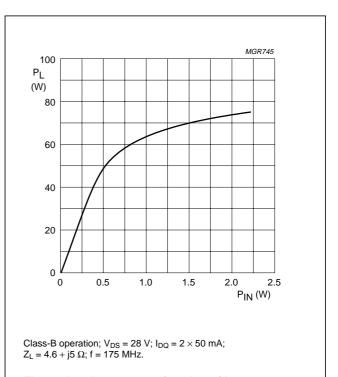
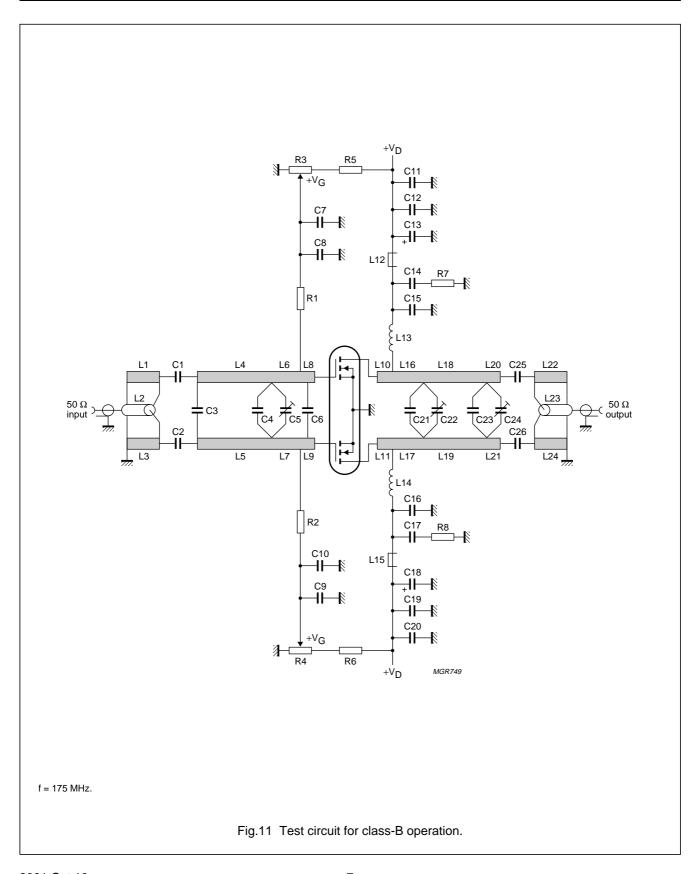


Fig.10 Load power as a function of input power; typical values per section.

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VHF push-pull power MOS transistor

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List of components class-B test circuit (see Figs 11 and 12)

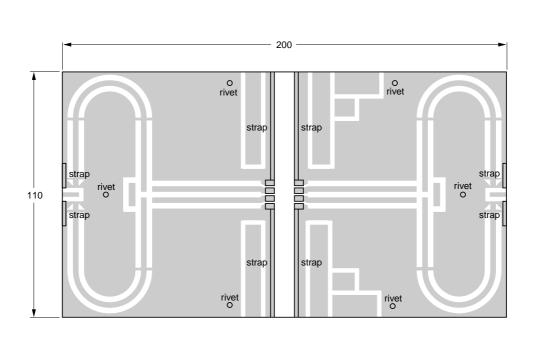
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE No.
C1, C2, C25, C26	multilayer ceramic chip capacitor; note 1	91 pF		
C3	film dielectric trimmer	4 to 40 pF		2222 809 08002
C4	multilayer ceramic chip capacitor; note 1	180 pF		
C5, C22, C24	film dielectric trimmer	5 to 60 pF		2222 809 08003
C6	multilayer ceramic chip capacitor; note 2	100 pF		
C7, C9, C12, C14, C17, C19	multilayer ceramic chip capacitor; note 1	100 nF		2222 852 47104
C8, C10	multilayer ceramic chip capacitor; note 1	680 pF		
C11, C20	multilayer ceramic chip capacitor	10 nF		2222 852 47103
C13, C18	electrolytic capacitor	10 μF, 63 V		
C15, C16, C21	multilayer ceramic chip capacitor; note 1	82 pF		
C23	multilayer ceramic chip capacitor; note 1	33 pF		
L1, L3, L22, L24	stripline; note 3	55 Ω	111 × 2.5 mm	
L2, L23	semi-rigid cable	50 Ω	length 111 mm ext. dia 2.2 mm	
L4, L5	stripline; note 3	50 Ω	38 × 2.8 mm	
L6, L7	stripline; note 3	50 Ω	9 × 2.8 mm	
L8, L9	stripline; note 3	50 Ω	8 × 2.8 mm	
L10, L11	stripline; note 3	50 Ω	11 × 2.8 mm	
L12, L15	grade 3B Ferroxcube wideband HF choke			4312 020 36642
L13, L14	4 turns enamelled 1 mm copper wire	50 nH	length 6.5 mm int. dia. 4 mm leads 2 × 5 mm	
L16, L17	stripline; note 3	50 Ω	16 × 2.8 mm	
L18, L19	stripline; note 3	50 Ω	25 × 2.8 mm	
L20, L21	stripline; note 3	50 Ω	3 × 2.8 mm	
R1, R2	metal film resistor	0.4 W, 10 Ω		
R3, R4	10 turns potentiometer	50 kΩ		
R5, R6	metal film resistor	0.4 W, 205 kΩ		
R7, R8	metal film resistor	1 W, 21.5 Ω		

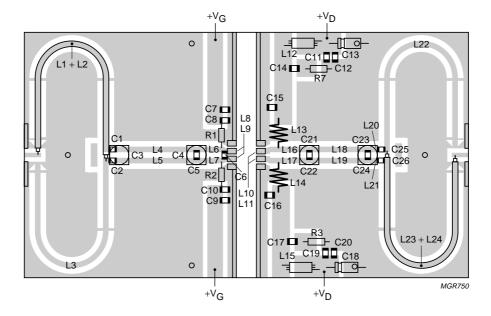
Notes

- 1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
- 2. American Technical Ceramics (ATC) capacitor, type 100A or other capacitor of the same quality.
- 3. The striplines are on a double copper-clad printed-circuit board with epoxy glass dielectric ($\epsilon_r = 4.5$); thickness 1/16 inch. The other side of the board is fully metallized and used as a ground plane. The ground planes on each side of the board are connected together by means of copper straps and hollow rivets.

VHF push-pull power MOS transistor

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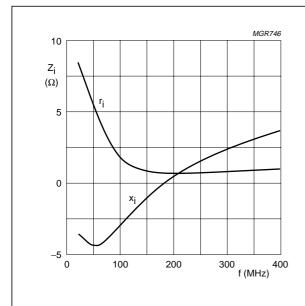
Dimensions in mm.

The circuit and components are situated on one side of the PTFE fibre-glass board, the other side being fully metallized, to serve as a ground plane. Earth connections are made by means of copper straps and hollow rivets for a direct contact between upper and lower sheets.

Fig.12 Component layout for 175 MHz class-B test circuit.

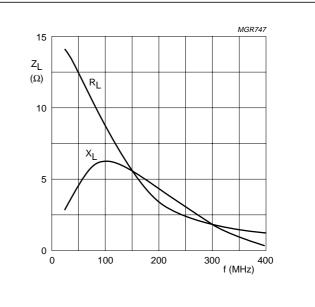
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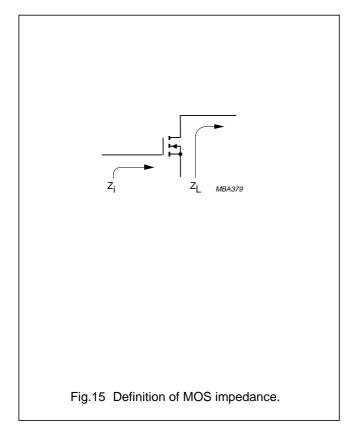
Class-B operation; V_{DS} = 28 V; I_{DQ} = 2 × 50 mA; R_{GS} = 10 Ω ; P_L = 60 W (total device).

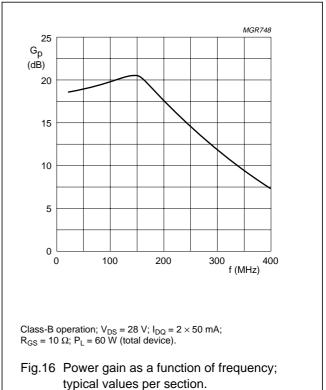
Fig.13 Input impedance as a function of frequency (series components); typical values per section.



Class-B operation; V_{DS} = 28 V; I_{DQ} = 2 × 50 mA; R_{GS} = 10 Ω ; P_L = 60 W (total device).

Fig.14 Load impedance as a function of frequency (series components); typical values per section.





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PACKAGE OUTLINE

UNIT

2.93

2.66

7.27

6.47

2.04

1.77

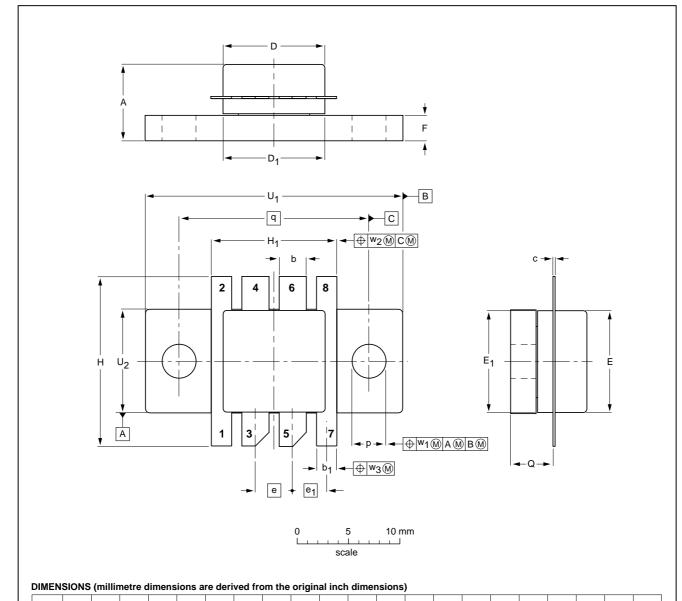
0.18

0.10

0.286 | 0.115 | 0.080 | 0.007 | 0.402 | 0.402 | 0.402 | 0.402

Flanged ceramic package; 2 mounting holes; 8 leads

SOT161A



OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT161A						99-03-29 99-10-04

2.70

2.08

 H_1

0.106 0.662 0.505 0.131 0.170 0.082 0.638 0.495 0.121 0.160

3.33 3.07 4.32 4.06

16.81 12.83 16.21 12.57 U_1

24.97

24.71

0.983 0.407

18.42

0.725

 U_2

10.34

10.08

w₁

0.25

0.51

0.010 0.020 0.010

w₃

0.25

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 D_1

10.22

10.00

10.21 10.21 10.21 9.94 10.00 9.94

3.80

3.50

0.150 0.138

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DATA SHEET STATUS

DATA SHEET STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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NOTES

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Printed in The Netherlands

613524/06/pp16

Date of release: 2001 Oct 10

Document order number: 9397 750 08678

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